

## SEMICELL CAL-DIODE

SKCD

$I_F = A$

$V_{RRM} = V$

Size: mm X mm

Package:

Features

Typical Applications

Absolute Maximum Ratings			
Symbol	Conditions	Values	Units
$V_{RRM}$	$T_{vj} = ^\circ C, I_R = mA$		V
$I_{F(AV)}$	$T_{vjmax} = ^\circ C$		A
$I_{FSM}$	$T_{vj} = ^\circ C,$ $T_{vjmax} = ^\circ C,$		A
$T_{vjmax}$			$^\circ C$

Electrical Characteristics					
Symbol	Conditions	min.	typ.	max.	Units
$I^2t$	$T_{vjmax}$				A <sup>2</sup> s
$I_R$	$T_{vj} = ^\circ C, V_{RRM}$				mA
$V_F$	$T_{vj} = ^\circ C, V_{RRM}$ $T_{vj} = ^\circ C, I_F = A$ $T_{vj} = ^\circ C, I_F = A$				V
$V_{(TO)}$	$T_{vj} = ^\circ C$				V
$r_T$	$T_{vj} = ^\circ C$				m $\Omega$

Dynamic Characteristics					
Symbol	Conditions	min.	typ.	max.	Units
$t_{rr}$	$T_{vj} = ^\circ C, V, A/\mu s$ $T_{vj} = ^\circ C, V, A/\mu s$				ns
$Q_{rr}$	$T_{vj} = ^\circ C, A, V, A/\mu s$ $T_{vj} = ^\circ C, A, V, A/\mu s$				$\mu C$
$I_{rrm}$	$T_{vj} = ^\circ C, A, V, A/\mu s$ $T_{vj} = ^\circ C, A, V, A/\mu s$				A

Thermal Characteristics					
Symbol	Conditions	min.	typ.	max.	Units
$T_{vj}$					$^\circ C$
$T_{stg}$					$^\circ C$
$T_{solder}$	min				$^\circ C$
$T_{solder}$	min				$^\circ C$
					K / W

Mechanical Characteristics		
Parameter		Units
raster size		mm
Area total		mm <sup>2</sup>
Chips / wafer		pcs
Anode metallisation		
Cathode metallisation		
wire bond		

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